



Docket No.: M4065.0454/P454  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Jerome Eldridge et al.

Application No.: 09/929,350

Art Unit: 2815

Filed: August 15, 2001

Examiner: C. C. Chu

For: INTERNAL HYDROGEN SOURCES FOR  
HEAT CONDUCTIVE PACKAGING OF  
LOW DIELECTRIC CONSTANT  
SEMICONDUCTOR CHIPS, AND  
METHOD OF PROVIDING HYDROGEN  
THEREFOR

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated February 9, 2004 (Paper No. 17), please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 38 of this paper 36/09/2834 JNCXILLA 28062002 041073 09929353

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